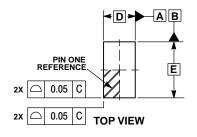
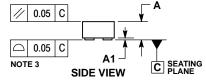
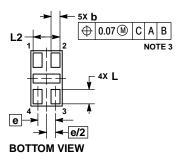


X3DFN4 0.525x0.925, 0.3P CASE 714AA **ISSUE B**

DATE 08 DEC 2014







NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. 2. CONTROLLING DIMENSION: MILLIMETERS. 3. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.24	0.32	
A1	0.00	0.05	
b	0.12	0.18	
D	0.525 BSC		
Е	0.925 BSC		
e	0.30 BSC		
L	0.173	0.233	
L2	0.42	0.48	

GENERIC MARKING DIAGRAM*

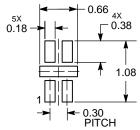


= Specific Device Code Χ

= Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present.

RECOMMENDED SOLDER FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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NEW STANDARD:			
DESCRIPTION:	X3DFN4 0.525X0.925, 0.3P		PAGE 1 OF 2



DOCUMENT	NUMBER:
98AON89145	5F

PAGE 2 OF 2

	1	<u> </u>
ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION. REQ. BY D. TRUHITTE.	31 JUL 2014
А	CHANGED POSITIONAL TOLERANCE VALUE IN TOP VIEW FROM 0.08 TO 0.05. REQ. BY D. TRUHITTE.	21 OCT 2014
В	CHANGED DESCRIPTION FROM X2LLGA4 TO X3DFN4. REQ. BY D. TRUHITTE.	08 DEC 2014

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